## **BTM52**

## **Bluetooth Module Data Sheet**

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# **Revision History**

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|------------|---------|-----------------------------|--------|
| 2012-03-14 | V1.0    | ■ First Release             |        |
| 2012-04-20 | V1.01   | ■ Add to support A2DP Codes |        |
|            |         |                             |        |
|            |         |                             |        |
|            |         |                             |        |
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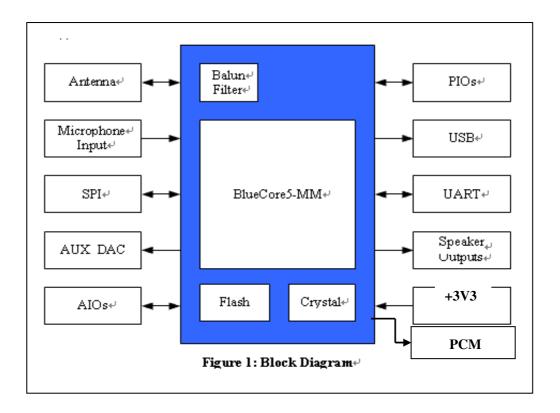
#### 1. INTRODUCTION

The BTM52 Bluetooth<sup>®</sup> module is a perfect solution for enhanced audio applications, such as stereo headphones and high performance automobile handsfree. It can be connected with any Bluetooth<sup>®</sup> devices in an operating range. It is slim and light so the designers can have better flexibilities for the product shapes.

The BTM52 Bluetooth® module complies with Bluetooth® specification version 2.1. It supports HSP, HFP, A2DP, AVRCP, PBAP, SPP, profiles. It integrates RF Baseband controller, antenna, etc. and provides UART interface, programmable I/O, stereo speaker output, microphone input, etc.

The detail information of BTM52 Bluetooth® module is presented in this document below.

#### 1.1 Block Diagram



#### 1.2 Features

- ✓ Small overall dimension(15mm x 20mm x 2mm)
- ✓ Bluetooth Specification V2.1
- ✓ Class 2 and Class 3 support
- √ Physical connection as SMD type
- ✓ DSP Co-Processor 16-bit Internal Stereo CODEC with -95dB SNR for DAC.
- ✓ High quality stereo audio (sample rate up to 44.1KHz)
- ✓ Supports A2DP Codecs: SBC(mandatory); MPEG-1,2 Audio / MPEG-2,4 AAC / ATRAC family / APTX (optional)
- ✓ Built-in RF combo filter, Integrated 26M Crystal.
- ✓ Supports up to 8 Mbits/16 Mbits on module flash memory.
- ✓ Support phonebook download from mobile phones to serial flash.
- ✓ Support phonebook sorting and searching.
- ✓ Support DFU for firmware upgrade.
- ✓ Support DUN for internet access.
- ✓ Support active inquires BT device and pairing.
- ✓ Support HSP, HFP, A2DP, AVRCP, OPP, SPP, PBAP, SYNC, PB-Sync for Nokia, PB-Sync For Samsung profile.
- ✓ Support active inquires BT device and pairing.
- ✓ Support customizable PIN code and device name.
- ✓ Support pairing up to 8 Bluetooth<sup>®</sup> device.
- ✓ Compatible with CSR cVc software echo cancellation solution.
- ✓ No radio signal interference, support for 802.11 co-existence
- \* Some features are optional for customization on demand.

### 1.3 Application

- ✓ Automobile hands-free applications
- √ Hands-Free Car Kits for embedded Car audio systems
- ✓ Bluetooth Audio source gateway and data gateways for PND systems
- ✓ High Quality Stereo Bluetooth Headsets
- ✓ High Quality Mono Bluetooth Headsets
- √ Bluetooth Speakers
- ✓ Industrial sensors and controls
- ✓ Measurement and monitoring systems

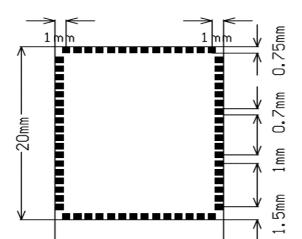


## 2. GENERAL SPECIFICATION

| Dhrotooth Crooke4'      |  |
|-------------------------|--|
| Bluetooth Specification |  |
| Chip Set                | CSR BC05-MultiMedia External   |
| Module ID               | BTM52  |
| BT Standard             | Bluetooth® V2.1 + EDR specification  |
| RF TX Output Power      | 4dBm (Class II)  |
| Sensitivity             | -86dBm@0.1%BER   |
| Frequency Band          | 2.402GHz~2.480GHz ISM Band   |
| Baseband Crystal OSC    | 26MHz  |
| Hopping                 | 1600hops/sec, 1MHz channel space   |
| RF Input Impedance      | 50 ohms  |
| Major Interface         | <ul> <li>Microphone : Input (Differential)</li> <li>Speaker : Output (Differential)</li> <li>PCM : Output</li> <li>UART : Tx/Rx</li> <li>USB : DP/DN</li> <li>PIOs</li> <li>Antenna</li> </ul> |
| Profile                 | HSP, HFP, A2DP, AVRCP, PBAP,  detailed profiles depends on the firmware  |
| Voice Processor         | 64MIPS Kalimba with cVc support  |
| Power                   |  |
| Supply Voltage          | 3.0V ~ 3.6V DC   |
| Working Current         | 35mA typical, Depends on profiles  |
| Standby Current         | <1mA   |
| Operating Environment   |  |
| Temperature             | -40°C to +85°C   |
| Humidity                | 10%~90% Non-Condensing   |
| Environmental           | RoHS Compliant   |

#### 3. PHYSICAL CHARACTERISTIC

## **Dimension:**



15mm

#### **Top View:**

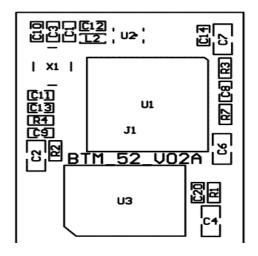


Figure 2 Figure 3

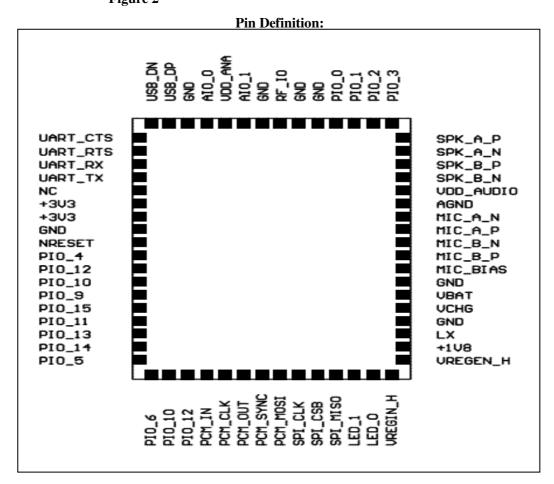


Figure 4

## 3.1 Pin Description

| Pin# | Pin Name | Pad Type  | Description  |
|------|----------|---|--|
| 1    | UART_CTS | CMOS input with weak internal pull-down                                 | UART clear to send active low  |
| 2    | UART_RTS | Bi-directional CMOS output,<br>tri-state, with weak internal<br>pull-up | UART request to send active low  |
| 3    | UART_RX  | CMOS input with weak internal pull-down                                 | UART data input  |
| 4    | UART_TX  | Bi-directional CMOS output,<br>tri-state, with weak internal pull-up    | UART data output   |
| 5    | NC       | NC  | NC   |
| 6    | +3V3     | VDD   | Positive supply for BT Module (3.2V~3.6V)                              |
| 7    | +3V3     | VDD   | Positive supply for BT Module(3.2V~3.6V)                               |
| 8    | GND      | Ground  | Digital Ground   |
| 9    | NRESET   | CMOS input with weak internal pull-up                                   | Reset if low. Input debounced so must be low for >5ms to cause a reset |
| 10   | PIO[4]   | Bi-directional with programmable strength internal pull-up/down         | Programmable input/output line   |
| 11   | PIO[12]  | Bi-directional with programmable strength internal pull-up/down         | Programmable input/output line   |
| 12   | PIO[10]  | Bi-directional with programmable strength internal pull-up/down         | Programmable input/output line   |
| 13   | PIO[9]   | Bi-directional with programmable strength internal pull-up/down         | Programmable input/output line   |
| 14   | PIO[15]  | Bi-directional with programmable strength internal pull-up/down         | Programmable input/output line   |

| 15 | PIO[11] | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |
|----|---------|---|--------------------------------|
| 16 | PIO[13] | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line |

| ttp:// | www.buddios-toch.co |
|--------|---------------------|

| http: | ttp://www.buddies-tech.com BTM52 DATASHE |   |  |  |  |
|-------|--|---|--|--|--|
| 17    | PIO[14]                                  | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line                               |  |  |
| 18    | PIO[5]                                   | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line                               |  |  |
| 19    | PIO[6]                                   | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line                               |  |  |
| 20    | PIO[10]                                  | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line                               |  |  |
| 21    | PIO[12]                                  | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line                               |  |  |
| 22    | PCM_IN                                   | CMOS input, with weak internal pull-down                        | Synchronous data input                                       |  |  |
| 23    | PCM_CLK                                  | Bi-directional with weak internal pull-down                     | Synchronous data clock                                       |  |  |
| 24    | PCM_OUT                                  | CMOS output, tri-state, with weak internal pull-down            | Synchronous data output                                      |  |  |
| 25    | PCM_SYNC                                 | Bi-directional with weak internal pull-down                     | Synchronous data sync  |  |  |
| 26    | SPI_MOSI                                 | CMOS input, with weak internal pull-down                        | SPI data input   |  |  |
| 27    | SPI_CLK                                  | Input with weak internal pull-down                              | SPI clock  |  |  |
| 28    | SPI_CSB                                  | Input with weak internal pull-up                                | Chip select for Serial Peripheral Interface (SPI),active low |  |  |
| 29    | SPI_MISO                                 | CMOS output, tri-state, with weak internal pull-down            | SPI data output  |  |  |
| 30    | LED[1]                                   | Open drain output   | LED driver   |  |  |

| 31 | LED[0]   | Open drain output                  | LED driver  |
|----|----------|------------------------------------|---|
| 32 | VREGIN_H | Regulator input                    | Input to internal high-voltage linear regulator (2.5V~4.9V)                 |
| 33 | VREGEN_H | Analogue                           | Take high to enable high-voltage linear regulator and switch-mode regulator |
| 34 | +1V8     | Supply                             | High-voltage linear regulator output (1.8V out)                             |
| 35 | LX       | Switch-mode power regulator output | Switch-mode power regulator output (1.8V out)                               |

10

| http | ://www.buddies | -tech.com            | BTM52 DATASHEET  |  |
|------|----------------|----------------------|--|--|
| 36   | GND            | Ground               | Digital Ground   |  |
| 37   | VCHG           | Charger input        | Lithium ion/polymer battery charger input (4.5V~6.5V)  |  |
| 38   | VBAT           | Battery terminal +ve | Lithium ion/polymer battery positive terminal.  Battery charger output and input to switch-mode regulator (4.2V out) |  |
| 39   | GND            | Ground               | Digital Ground   |  |
| 40   | MIC_BIAS       | Analogue             | Microphone bias  |  |
| 41   | MIC_B_P        | Analogue             | Microphone input positive, right   |  |
| 42   | MIC_B_N        | Analogue             | Microphone input negative, right   |  |
| 43   | MIC_A_P        | Analogue             | Microphone input positive, left  |  |
| 44   | MIC_A_N        | Analogue             | Microphone input negative, left  |  |
| 45   | AGND           | Ground               | Analogue Ground  |  |

| 48 | SPK_B_P | Analogue  | Speaker output positive, right                 |  |
|----|---------|---|--|--|
| 49 | SPK_A_N | Analogue  | Speaker output negative, left                  |  |
| 50 | SPK_A_P | Analogue  | Speaker output positive, left                  |  |
| 51 | PIO[3]  | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line                 |  |
| 52 | PIO[2]  | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line (external TXEN) |  |
| 53 | PIO[1]  | Bi-directional with programmable strength internal pull-up/down | Programmable input/output line                 |  |

VDD\_AUDIO Bi-directional VDD/Low-voltage regulator output

Analogue

46

47

SPK\_B\_N

Analogue programmable input/ output line

circuitry and 1.5V regulated output (from

internal low-voltage regulator)

Speaker output negative, right



| http: | nttp://www.buddies-tech.com |  | BTM52 DATASHEET  |  |
|-------|-----------------------------|--|--|--|
| 54    |                             | Bi-directional with programmable                   | Programmable input/output line (external   |  |
| 34    | PIO[0]                      | strength internal pull-up/down                     | RXEN)  |  |
| 55    | GND                         | Ground   | Digital Ground   |  |
| 56    | GND                         | Ground   | Digital Ground   |  |
| 57    | RF_IO                       | RF   | RF out   |  |
| 58    | GND                         | Ground   | Digital Ground   |  |
| 59    | AIO[1]                      | Bi-directional                                     | Analogue programmable input/ output line   |  |
| 60    |                             | Bi-directional<br>VDD/Low-voltage regulator output | Analogue programmable input/ output line circuitry and 1.5V regulated output (from internal low-voltage regulator) |  |
| 61    | AIO[0]                      | Bi-directional                                     | Analogue programmable input/ output line   |  |
| 62    | GND                         | Ground   | Digital Ground   |  |
| 63    | USB_DP                      | Bi-directional                                     | USB data plus with selectable internal $1.5k\Omega$ pull-up resistor   |  |
| 64    | USB_DN                      | Bi-directional                                     | USB data minus   |  |

## 4. REFERENCE SCHEMATIC

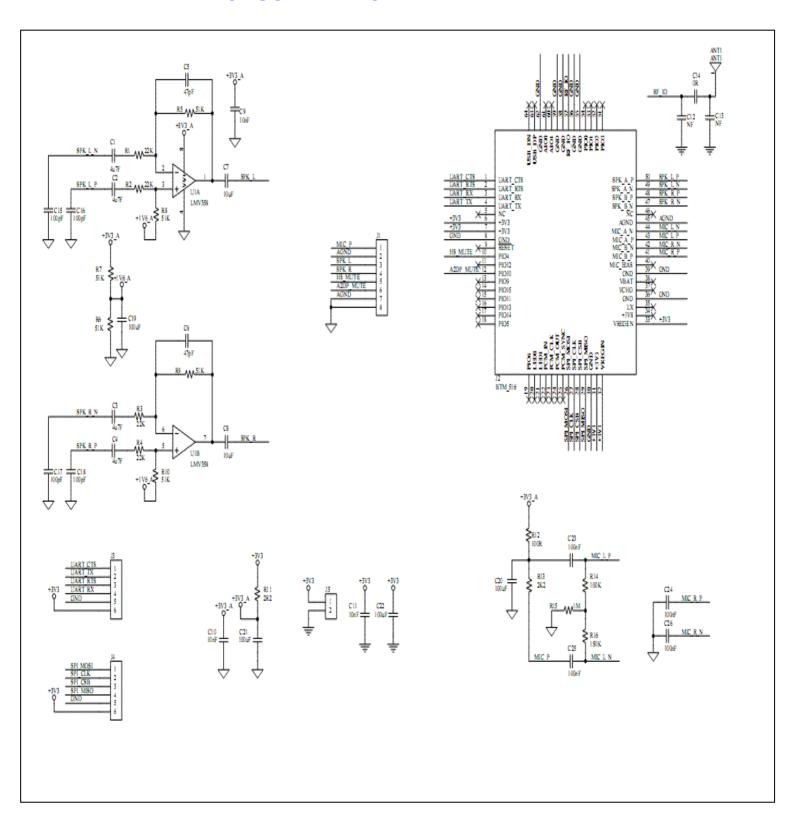


Figure 5

#### 5. PHYSICAL INTERFACE

### **5.1** Power Supply

The transient response of the regulator is important. If the power rails of the module are supplied from an external voltage source, the transient response of any regulator used should be 20µs or less.

#### 5.2 Reset

The module may be reset from several sources: NRESET pin, power-on reset, a UART break character or via a software configured watchdog timer.

The NRESET pin is an active low reset and is internally filtered using the internal low frequency clock oscillator. A reset will be performed between 1.5 and 4.0ms following RESETB being active.

It is recommended that RESETB be applied for a period greater than 5ms.

At reset the digital I/O pins are set to inputs for bi-directional pins and outputs are tri-state. The PIOs have weak pull-ups.

#### 5.3 Audio Interfaces

Audio interface as following features:

- Mono analogue input for voice band and audio band
- Stereo and mono analogue output for voice band and audio band

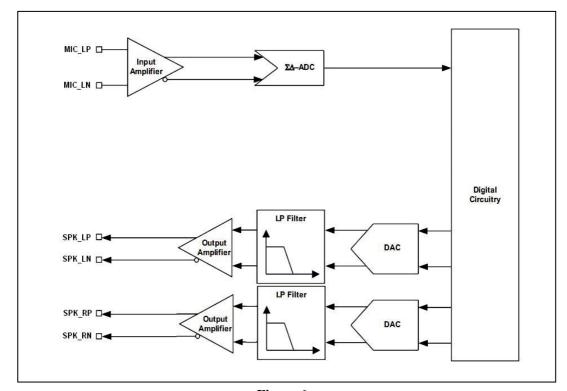


Figure 6

The stereo audio CODEC uses a fully differential architecture in the analogue signal path, which results in low noise sensitivity and good power supply rejection while effectively doubling the signal amplitude. It uses a minimum of external components. The module features a differential stereo audio output interfaces.

#### 5.3.1 ADC

The ADC consists of a second order Digma Delta converter as show in Figure 6.

#### 5.3.2 ADC Sample Rate Selection and Warping

ADC supports the following sample rates: 8kHz, 11.025kHz, 16kHz, 22.05kHz, 24kHz, 32kHz,44.1kHz.

One of the main concerns for stereo wireless music applications is the ability to keep sampl rates forthe CODECs at both ends of the wireless link in synchronization. A VM function adjusts the sample rate using a 'warping' function to tune the sample rate to the required value. The ADC warp function allows the sample rate to be changed by +/-3%, in steps of  $1/2^{17}$ , or 7.6ppm. The warp function preserves the signal quality – the distortion introduced when warping the sample rate is negligible.

#### **5.3.3 ADC Gain**

The ADC contains two gain stages for each channel, an analogue and a digital gain stage.

#### 5.3.4 DAC

The DAC contains two second order Sigma Delta converters allowing two separate channels that are identical in functionality as show in **Figure 6**.

#### 5.3.5 DAC Sample Rate Selection and Warping

Each DAC supports the following sample rates: 8kHz, 11.025kHz, 16kHz, 22.05kHz, 24kHz, 32kHz,44.1kHz, 48kHz.

One of the main concerns for the DAC used in stereo wireless music applications is the ability to keep sampl rates for the CODECs at both ends of the wireless link in synchronization. A VM function adjusts the sample rate using a 'warping' function to tune the sample rate to the required value. The ADC warp function allows the sample rate to be changed by +/-3%, in steps of 1/2<sup>17</sup>, or 7.6ppm. The warp function preserves the signal quality – the distortion introduced when warping the sample rate is negligible.

#### **5.3.6 DAC Gain**

The DAC contains two gain stages for each channel, a digital and an analogue gain stage.

#### **5.3.7** Mono Operation

Mono operation is single channel operation of the stereo CODEC. The left channel represents the single mono channel for audio in and audio out. In mono operation the right channel is auxiliary mono channel that may be used in dual mono channel operation.

#### 5.3.8 Audio Input Stage

The audio input stage of the module consists of a low noise input amplifier, which receives its analogue input signal from pins MIC\_A\_P and MIC\_A\_N to a second—order  $\Sigma$ - $\Delta$  ADC that outputs a 4Mbit/sec single-bit stream into the digital circuitry. The input can be configured to be either single ended or fully differential. It can be programmed for either microphone or line input and has a 3-bit digital gain setting of the input-amplifier in 3dB steps to optimize it for the use of different microphones.

#### **5.3.9** Microphone Input

Check the reference design in Figure 5 for the microphone input design.

#### 5.3.10 Audio Output Stage

The output digital circuitry converts the signal from 16-bit per sample, linear PCM of variable sampling frequency to a 2Mbits/sec multi-bit stream, which is fed into the analogue output circuitry.

The output circuit comprises a digital to analogue converter with gain setting and output amplifier. Its class-AB output-stage is capable of driving a signal on both channels of up to 2V pk-pk- differential into a load of  $16\Omega$ . The output is available as a differential signal between SPK\_A\_P and SPK\_A\_N for the left channel; and between SPK\_B\_P and SPK\_B\_N for the right channel. The output is capable of driving a speaker directly if its impedance is at least  $8\Omega$  if only one channel is connected or an external regulator is used.

The gain of the output stage is controlled by a 3-bit programmable resistive divider, which sets the gain in steps of approximately 3dB.

The multi-bit stream from the digital circuitry is low pass filtered by a second order bi-quad filter with a pole at 20kHz. The signal is then amplified in the fully differential output stage, which has a gain bandwidth of typically 1MHz.

#### 5.3.11 PCM

The audio pulse code modulation (PCM) interface supports continuous transmission and reception of PCM encoded audio data over Bluetooth.

Pulse Code Modulation (PCM) is a standard method used to digitize audio (particularly voice) for transmission over digital communication channels. Through its PCM interface, BTM52 provide hardware support for continual transmission and reception of PCM data, thus reducing processor overhead for wireless headset applications. BTM52 offers a bi-directional digital audio interface that routes directly into the baseband layer of the on-chip firmware. It does not pass through the HCI protocol layer.

Hardware on BTM52 allows the data to be sent to and received from a SCO connection. Up to three SCO connections can be supported by the PCM interface at any time.

#### **5.4 RF** Interface

The module integrates a balun filter. The user can connect a 50ohms antenna directly to the RF port.

### 5.5 General Purpose Analog IO

The general purpose analog IOs can be configured as ADC inputs by software. Do not connect them if not use.

### 5.6 General Purpose Digital IO

There are nine general purpose digital IOs defined in the module. All these GPIOs can be configured by software to realize various functions, such as button controls, LED displays or interrupt signals to host controller, etc. Do not connect them if not use.

#### **5.7** Serial Interfaces

#### **5.7.1 UART**

This is a standard UART interface for communicating with other serial devices. The UART interface provides a simple mechanism for communicating with other serial devices using the RS232 protocol.

When the module is connected to another digital device, UART\_RX and UART\_TX transfer data between the two devices. The remaining two signals, UART\_CTS and UART\_RTS, can be used to implement RS232 hardware flow control where both are active low indicators.

#### 5.7.2 USB

There is a full speed (12M bits/s) USB interface for communicating with other compatible digital devices. The module acts as a USB peripheral, responding to request from a master host controller, such as a PC.

The module features an internal USB pull-up resistor. This pulls the USB\_DP pin weakly high when module is ready to enumerate. It signals to the USB master that it is a full speed (12Mbit/s) USB device. The USB internal pull-up is implemented as a current source, and is compliant with section7.1.5 of the USB specification v1.2. The internal pull-up pulls USB\_DP high to at least 2.8V when loaded with a 15k $\Omega$  ±5% pull-down resistor (in the hub/host) when VDD =3.1V. This presents a Thevenin resistance to the host of at least 900 $\Omega$ . Alternatively, an external 1.5k $\Omega$  pull-up resistor can be placed between a PIO line and DP on the USB cable.

#### **5.7.3 SPI**

The synchronous serial port interface (SPI) can be used for system debugging. It can also be used for in-system programming for the flash memory within the module. SPI interface uses the SPI\_MOSI, SPI\_MISO, SPI\_CSB and SPI\_CLK pins. Testing points for the SPI interface are reserved on board in case that the firmware shall be updated during manufacture.

The module operates as a slave and thus SPI\_MISO is an output of the module. SPI\_MISO is not in high-impedance state when SPI\_CSB is pulled high. Instead, the module outputs 0 if the processor is running and 1 if it is stopped. Thus the module should NOT be connected in a multi-slave arrangement by simple parallel connection of slave SPI\_MISO lines.

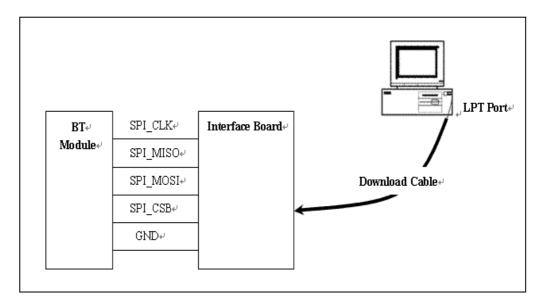
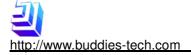


Figure 7



## **6. ELECTRICAL CHARACTERISTIC**

## **6.1** Absolute Maximum Rating

| Rating                            | Min  | Max     | Unit |
|-----------------------------------|------|---------|------|
| Storage Temperature               | -40  | +125    | °C   |
| Operating Temperature             | -40  | +85     | °C   |
| PIO/AIO Voltage                   | -0.4 | +3.6    | V    |
| +3V3 Voltage                      | -0.4 | +3.6    | V    |
| USB_DP/USB_DN Voltage             | -0.4 | +3.6    | V    |
| Other Terminal Voltages except RF | -0.4 | 3V3+0.4 | V    |

Table 1

## **6.2** Recommended Operating Conditions

| Operating Condition         | Min  | Typical | Max  | Unit |
|-----------------------------|------|---------|------|------|
| Operating Temperature Range | -40  |         | +85  | °C   |
| +3V3 Voltage                | +3.0 | +3.3    | +3.6 | V    |

Table 2

## **6.3** Input/output Terminal Characteristics

## **6.3.1 Digital Terminals**

| Supply Voltage Levels                                       | Min       | Typical | Max       | Unit |  |  |  |  |  |
|---|-----------|---------|-----------|------|--|--|--|--|--|
| Input Voltage Levels  |           |         |           |      |  |  |  |  |  |
| VIL input logic level low                                   | -0.3      | -       | +0.25x3V3 | V    |  |  |  |  |  |
| VIH input logic level high                                  | 0.625*3V3 | -       | 3V3+0.3   | V    |  |  |  |  |  |
| Output Voltage Levels                                       |           |         |           |      |  |  |  |  |  |
| $V_{OL}$ output logic level low, $l_{OL} = 4.0 \text{mA}$   | -         | -       | 0.125     | V    |  |  |  |  |  |
| $V_{OH}$ output logic level high, $l_{OH} = -4.0 \text{mA}$ | 0.75x3V3  | -       | 0.625x3V3 | V    |  |  |  |  |  |
| Input and Tri-state Current                                 |           |         |           |      |  |  |  |  |  |
| Ii input leakage current at Vin=+3V3 or 0V                  | -100      | 0       | 100       | nA   |  |  |  |  |  |
| Ioz tri-state output leakage current at Vo=+3V3 or 0V       | -100      | 0       | 100       | nA   |  |  |  |  |  |
| With strong pull-up   | -100      | -40     | -10       | μΑ   |  |  |  |  |  |
| With strong pull-down                                       | 10        | 40      | 100       | μΑ   |  |  |  |  |  |
| With weak pull-up   | -5        | -1.0    | -0.2      | μΑ   |  |  |  |  |  |
| With weak pull-down   | 0.        | +1.     | 5.0       | μΑ   |  |  |  |  |  |
|   | 2         | ^       |           |      |  |  |  |  |  |
| I/O pad leakage current                                     | -1        | 0       | +1        | μΑ   |  |  |  |  |  |

| p://www.buddies-tech.com                  |      | BTM52 | DATASHEET |    |
|---|------|-------|-----------|----|
| CI Input Capacitance                      | 1.   | -     | 5.0       | pF |
| Resistive Strength                        |      |       |           |    |
| Rpuw weak pull-up strength at +3V3-0.2V   | 500k | -     | 2M        | Ω  |
| Rpdw weak pull-up strength at 0.2V        | 500k | -     | 2M        | Ω  |
| Rpus strong pull-up strength at +3V3-0.2V | 10k  | -     | 50k       | Ω  |
| Rpds strong pull-up strength at 0.2V      | 10k  | -     | 50k       | Ω  |

Table 3

## 6.3.2 USB

| USB Terminals   | Min     | Typical | Max     | Unit |  |  |  |  |  |
|---|---------|---------|---------|------|--|--|--|--|--|
| Input Threshold   |         |         |         |      |  |  |  |  |  |
| V <sub>II.</sub> input logic level low                  | -       | -       | 0.3*3V3 | V    |  |  |  |  |  |
| V <sub>IH</sub> input logic level high                  | 0.7*3V3 | -       | -       | V    |  |  |  |  |  |
| Input Leakage Current                                   |         |         |         |      |  |  |  |  |  |
| $GND < VIN < +3V3^{(a)}$                                | -1      | 1       | 5       | μA   |  |  |  |  |  |
| CI Input capacitance                                    | 2.5     | _       | 10.0    | рF   |  |  |  |  |  |
| Output Voltage Levels to Correctly Terminated USB Cable |         |         |         |      |  |  |  |  |  |
| V <sub>II.</sub> output logic level low                 | 0.0     | _       | 0.2     | V    |  |  |  |  |  |
| V <sub>IH</sub> output logic level high                 | 2.8     | _       | +3V3    | V    |  |  |  |  |  |

Table 4

## **6.3.3** Internal CODEC - Analogue to Digital Converter

| Parameter  | Min | Typical | Max  | Unit |
|--|-----|---------|------|------|
| Resolution   | -   | -       | 16   | Bits |
| Input Sample Rate  | 8   | -       | 44.1 | kHz  |
| Signal / Noise, f <sub>in</sub> =1kHz, BW=20Hz->20kHz A-Weighted THD+N<1% 150mV Vpk-pk |     |         |      |      |
| $F_{\text{sample}} = 8kHz$   | -   | 82      | -    | dB   |
| $F_{\text{sample}} = 11.025 \text{kHz}$  | -   | 81      | -    | dB   |
| $F_{\text{sample}} = 16 \text{kHz}$  | -   | 80      | -    | dB   |
| $F_{\text{sample}} = 22.05 \text{kHz}$   | -   | 79      | -    | dB   |
| $F_{\text{sample}} = 32\text{kHz}$   | -   | 79      | -    | dB   |
| $F_{\text{sample}} = 44.1 \text{kHz}$  | -   | 78      | -    | dB   |
| Digital Gain   | -24 | _       | 21.5 | dB   |

Table 5



## http://www.buddies-tech.com 6.3.4 Internal CODEC - Digital to Analogue Converter

| Parameter                                       | Min | Typical | Max  | Unit |
|---|-----|---------|------|------|
| Resolution                                      | -   | -       | 16   | Bits |
| Output Sample Rate, Fsample                     | 8   | _       | 48   | kHz  |
| Signal / Noise, f <sub>in</sub> =1kHz, BW=20Hz- |     |         |      |      |
| >20kHz A-Weighted THD+N<0.01%                   |     |         |      |      |
| AJDEC signal Load 1001-0                        |     |         |      |      |
| $F_{\text{sample}} = 8\text{kHz}$               | -   | 95      | -    | dB   |
| $F_{\text{sample}} = 11.025 \text{kHz}$         | _   | 95      | -    | dB   |
| $F_{\text{sample}} = 16\text{kHz}$              | -   | 95      | -    | dB   |
| $F_{\text{sample}} = 22.05 \text{kHz}$          | -   | 95      | -    | dB   |
| $F_{\text{sample}} = 32\text{kHz}$              | -   | 95      | -    | dB   |
| $F_{\text{sample}} = 44 \text{kHz}$             | -   | 95      | -    | dB   |
| $F_{\text{sample}} = 48 \text{kHz}$             | -   | 95      | -    | dB   |
| Digital Gain                                    | -24 | -       | 21.5 | dB   |
| Gain Resolution                                 |     | 1/32    |      | dB   |

Table 6

## **6.3.5** Microphone Input

| Microphone Input                               | Min | Typical | Max | Unit   |
|--|-----|---------|-----|--------|
| Input full scale at maximum gain               | _   | 4       | -   | mV rms |
| Input full scale at minimum gian(differential) |     | 800     | -   | mV rms |
| Gain   | -3  | -       | 42  | dB     |
| Gain resolution                                | -   | 3       | -   | dB     |
| Distortion at 1kHz                             | -   | -       | -74 | dB     |
| 3dB Bandwidth                                  | -   | 20      |     | kHz    |
| Input impedance                                | -   | 6       |     | kΩ     |
| THD+N(microphone input)@30mV rms input         | _   | 0.04    | -   | %      |

Table 7

## 6.3.6 Speaker Output

| Speaker Driver                                 | Min | Typical | Max   | Unit   |
|--|-----|---------|-------|--------|
| Output voltage full scale swing (differential) | -   | 750     | -     | mV rms |
| THD+N 100kΩ load                               | -   | -       | 0.01% | %      |
| THD+N 16Ω load                                 | -   | _       | 0.1%  | %      |
| SNR(Load=16 $\Omega$ , 0dBFS input relative to | -   | 95      | -     | dB     |

Table 8

## **6.4** Power consumptions

| <b>Operating Condition</b>       | Min | Typical | Max | Unit |
|----------------------------------|-----|---------|-----|------|
| Connected Idle (Sniff 1.28 secs) |     | 0.19    |     | mA   |
| Connected with audio streaming   | 30  | 35      | 40  | mA   |
| Deep Sleep Idle mode             |     | 60      |     | uА   |

Table 9

### 7. RECOMMENDED TEMPERATURE REFLOW PROFILE

The soldering profile depends on various parameters necessitating a set up for each application. The data here is given only for guidance on solder reflow.



•

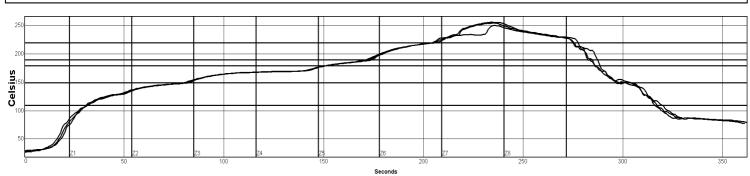
Friday March 09, 2012 10:21:21



Site:

Oven Name: WQ Process Window Name: 无铅

| Setpoints (Celsius) |               |     |     |     |     |     |     |     |  |
|---------------------|---------------|-----|-----|-----|-----|-----|-----|-----|--|
| Zone                | 1             | 2   | 3   | 4   | 5   | 6   | 7   | 8   |  |
| Top                 | 140           | 150 | 170 | 170 | 190 | 225 | 265 | 230 |  |
| Bottom              | 140           | 150 | 170 | 170 | 190 | 225 | 265 | 230 |  |
| Conveyor Speed ( cr | m/min ): 75.0 | )   |     |     |     |     |     |     |  |

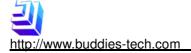


| PWI= 304% | Max Risi | ing Slope | Preheat | 110-190C | Soak Time | 2 150-180C | Reflow Ti | ime /220C | Peak  | Тетр |
|-----------|----------|-----------|---------|----------|-----------|------------|-----------|-----------|-------|------|
| 2         | 3.9      | 189%      | 141.4   | 157%     | 70.4      | -296%      | 71.1      | 111%      | 254.8 | 97%  |
| 3         | 4.0      | 197%      | 139.7   | 149%     | 70.6      | -294%      | 70.3      | 103%      | 250.6 | 11%  |
| 4         | 3.9      | 192%      | 142.1   | 160%     | 69.6      | -304%      | 71.2      | 112%      | 256.5 | 130% |
|           |          |           |         |          |           |            |           |           |       |      |

#### Process Window:

| older Paste. | 5151                    | DIVI DE | FAULI     |            |                |
|--------------|-------------------------|---------|-----------|------------|----------------|
| Statistic    | Name                    |         | Low Limit | High Limit | Units          |
| Max Ri       | sing Slope (Target=2.0) |         | 0.0       | 3.0        | Degrees/Second |
| Preheat      | Time 110-190C           |         | 90        | 130        | Seconds        |
| Soak Ti      | me 150-180C             |         | 90        | 110        | Seconds        |
| Time A       | bove Reflow - 220C      |         | 50        | 70         | Seconds        |
| Peak Te      | mperature               | 245     | 255       | Degr       | rees Celsius   |

#### Description:



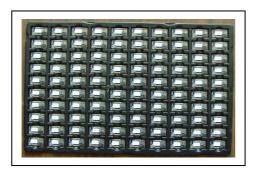
## 8. PACKAGING INFORMATION

1. BLUETOOTH® Module: BTM52





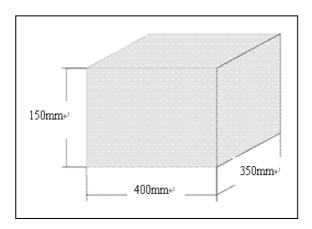
## 2. Assembly







#### 3. Dimension



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